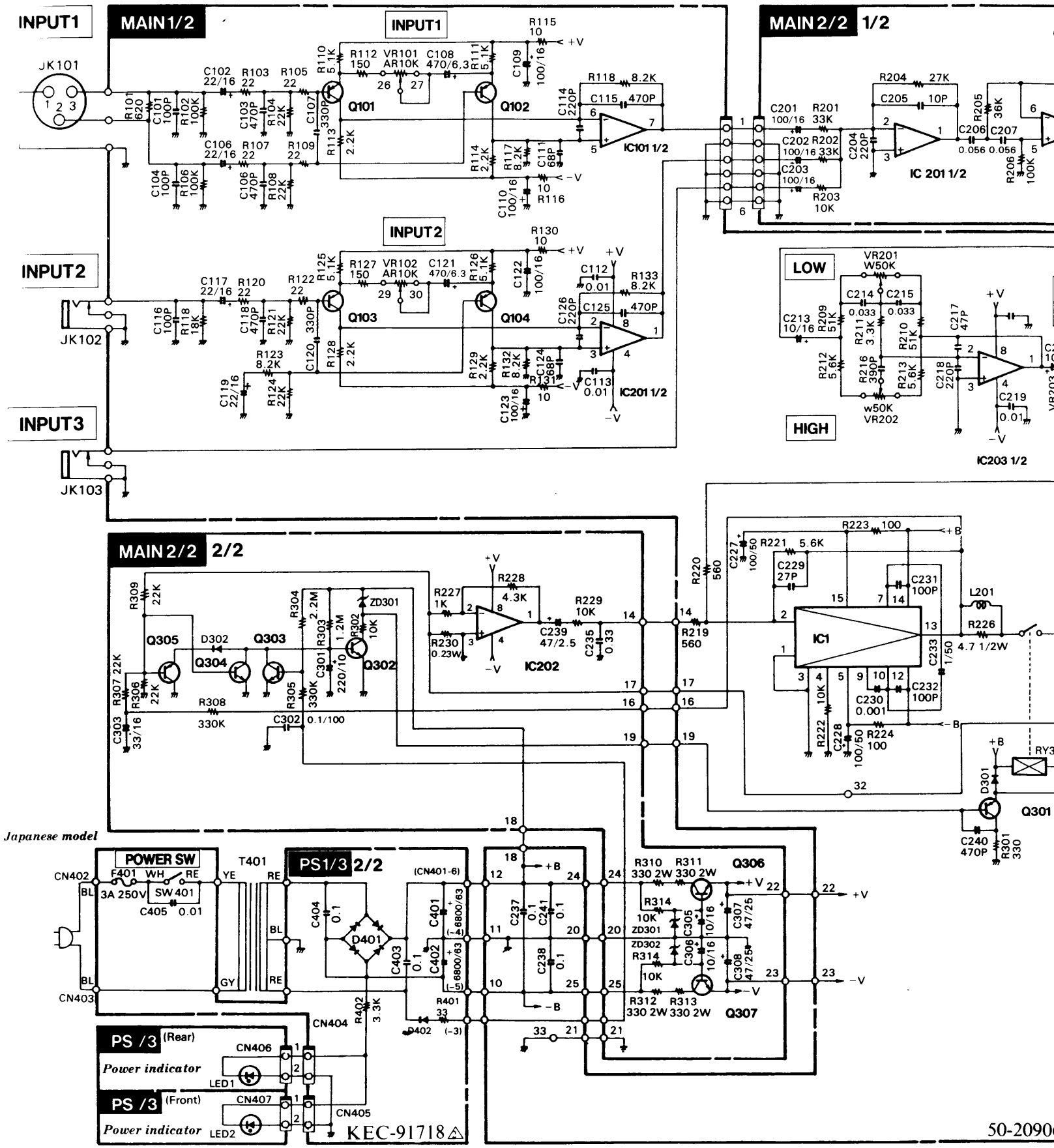
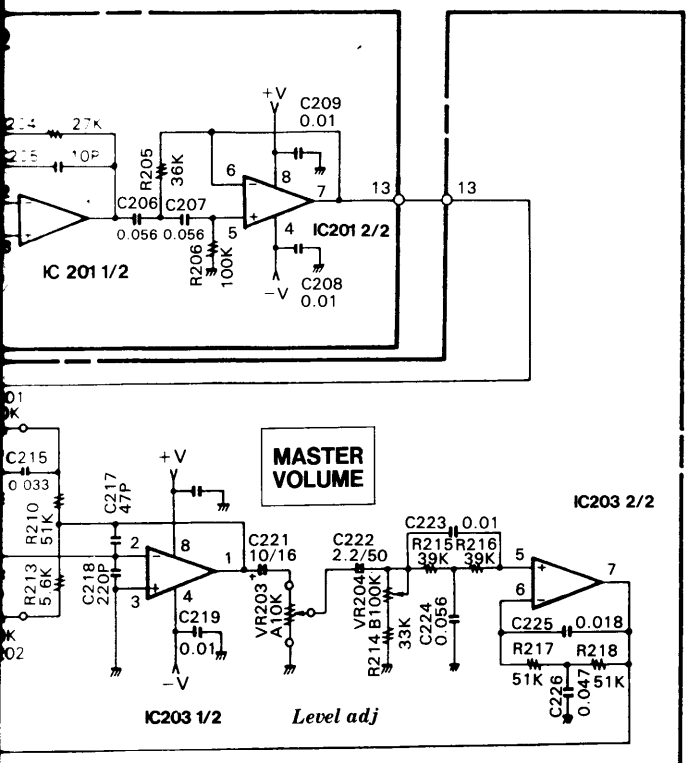
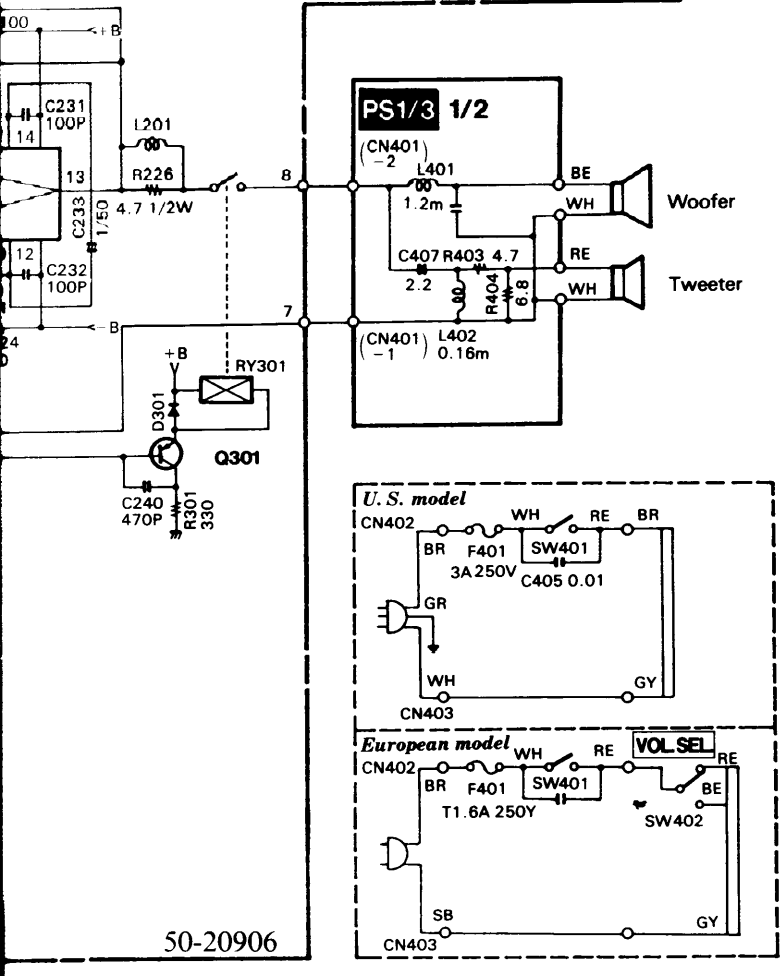
OVERALL CIRCUIT DIAGRAM (総回路図)







Notes)

※ Circuit Board :	MAIN (NX808890)
1. IC	
IC 1 :	STK4036-2 (IX802330) POWER AMP
IC101, 201, 203 :	NJM4558 DX (IX600120) OP AMP
IC202 :	NJM5532D-D (XA673001) OP AMP
2. Transistor	
Q101-104, 301, 305 :	2SA970 GR (IA097020)
Q302-304 :	2SC2240 GR (IC224020)
Q306 :	2SC2878A (IX804590)
Q307 :	2SA1015 GR (IA101531)
3. Diode	
D301, 302 :	MPG06B (IX802430)
4. Zener Diode	
D301 :	MTZJ24B (VG442500)
D302, 303 :	MTZJ15B (VG440800)
5. Variable Resistor	
VR101, 102 :	AR10K (HX805900) INPUT1, 2
VR201, 202 :	W50K (HX805910) LOW, HIGH
VR203 :	A10K (HX805890) MASTER
6. Trimmer Potentiometer	
VR204 :	B100K (HX805920) LEVEL adj
7. XLB Connector	
JK101 :	XLB-3-31 PCV-M01 (LB302320) INPUT1
8. Phone Jack	
JK102, 103 :	EX617BMB (LX802250) INPUT2, 3
9. Relay	
RY301 :	MR301 (24) (KX802540)

Notes)

Circuit Board :	PS (VI655200) XH414B0 J
Circuit Board :	PS (VI655300) XH414B0 U, C
Circuit Board :	PS (VI655400) XH414B0 H, B
1. Diode	
D402 :	1SS82 (IF001400)
2. Diode Stack	
D401 :	S4VB20 2.6A 200V (IH001090)
3. LED	
LED401 :	SLR-34VR5F RE (VG075800) POWER (REAR)
LED402 :	SLB-72VRHL5F RE (VI965700) POWER (FRONT)
4. Metal Oxide Film Resistor	
R402 :	3.3kΩ 1W J (VC735400)
5. Wire Wound Resistor	
R403 :	4.7Ω 5W K (VI343900)
R404 :	6.8Ω 5W (VI980400)
6. Flame Proof C. Resistor	
R401 :	33Ω 1/4 J (HV754330)
7. Electrolytic Cap.	
C401, 402 :	6800μF 63.0V (VI968500)
8. Ceramic Cap.	
C405 :	0.01μF 400V (FI384100)
9. Mylar Cap.	
C403, 404 :	0.1μF 400V K (VE013000)
10. Network Coil	
L401 :	1.2mm (VI959100)
L402 :	0.16mm (VI959000)
11. Fuse	
F401 :	T 3.00A 200V (KB000360) J
F401 :	T 3.00A 250V (KB002650) U, C
F401 :	T 1.60A 250V (KB001660) H, B
12. Terminal	
CN402, 403 :	(VA855400)